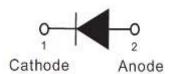


SURFACE MOUNT SUPER FAST RECTIFIER

DESCRIPTION:



The ALPER2J is Surface Mount Super Fast Rectifier with High forward surge current capability in Low profile package, low reverse leakage and it has high efficiency operation.



FEATURES:

- Super-fast switching for high efficiency
- Low reverse leakage
- > Built-in strain relief, ideal for automated placement
- High forward surge current capability
- ➤ The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- ➤ High temperature soldering guaranteed: 250°C / 10 seconds at terminals
- > Polarity: Color band denotes cathode
- ➤ Weight: 0.058 grams
- RoHS Compliant
- REACH Compliant

APPLICATIONS:

- Switching mode power supply (SMPS)
- Adapters
- Lighting application
- Converter



TYPICAL DEVICE CHARACTERISTICS

| MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted) | | | | | |
|--|-----------------------------------|--------------|------|--|--|
| PARAMETER | SYMBOL | ALPER2J | UNIT | | |
| Maximum repetitive peak reverse voltage | V _{RRM} | 600 | V | | |
| Maximum RMS voltage | V _{RMS} | 420 | V | | |
| Maximum DC blocking voltage | V_{DC} | 600 | V | | |
| Maximum average forward rectified current at T _A =55°C | I _(AV) | 2.0 | А | | |
| Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method) | lfsm | 50.0 | А | | |
| Maximum instantaneous forward voltage at 2.0A | V _F | 1.7 | V | | |
| Maximum DC reverse current T_A =25°C at rated DC blocking voltage T_A =100°C | I _R | 5.0 200.0 | μΑ | | |
| Maximum reverse recovery time (NOTE 1) | t _{rr} | 35 | ns | | |
| Typical junction capacitance (NOTE 2) | CJ | 60.0 | pF | | |
| Typical thermal resistance (NOTE 3) | $R_{\theta JA}$ | 40.0 | °C/W | | |
| Operating junction and storage temperature range | T _J , T _{STG} | -65 to 150 | °C | | |

NOTES:

- 1.Reverse recovery condition I $_{\rm F}$ =0.5A, I $_{\rm R}$ =1.0A, I $_{\rm rr}$ =0.25A
- 2. Measured at 1MHz and applied reverse voltage of 4.0V D.C.
- 3.P.C.B. mounted with 0.2 x 0.2" (5.0 x 5.0mm) copper pad areas



beyond boundaries ...

TYPICAL DEVICE CHARACTERISTICS CURVES (TA = 25 °C unless otherwise noted)

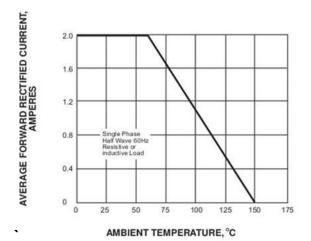


Fig.1 Forward Current Derating Curve

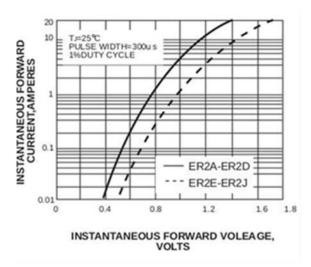


Fig.3 Typical Instantaneous Forward Characteristics

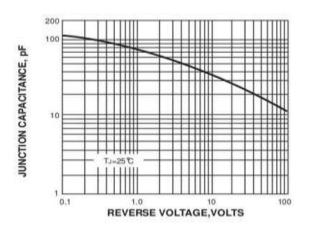


Fig.5 Typical Junction Capacitance

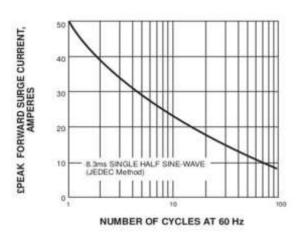


Fig.2 Maximum Non-Repetitive Peak Forward Surge Current

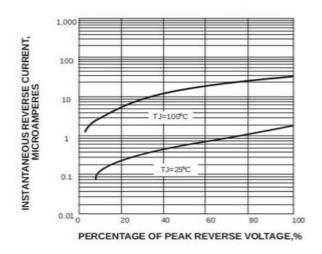


Fig.4 Typical Reverse Characteristics

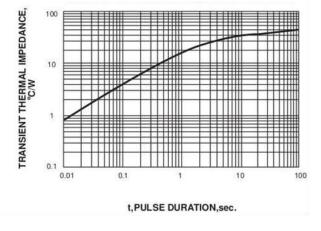
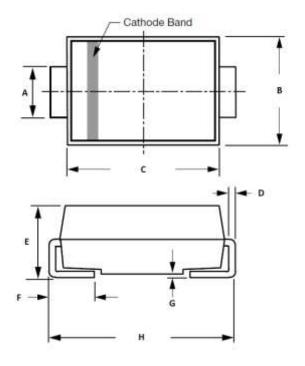


Fig.6 Typical Transient Thermal Impedance

PACKAGE INFORMATION

DO-214AC (SMA)



| OUTLINE DIMENSIONS | | | | | | |
|--------------------|-------------|-------|--------|-------|--|--|
| | MILLIMETERS | | INCHES | | | |
| DIM | MIN | MAX | MIN | MAX | | |
| Α | 1.29 | 2.21 | 0.051 | 0.087 | | |
| В | 2.18 | 2.80 | 0.086 | 0.110 | | |
| С | 3.99 | 4.57 | 0.157 | 0.180 | | |
| D | 0.152 | 0.305 | 0.006 | 0.012 | | |
| Е | 1.70 | 2.42 | 0.067 | 0.096 | | |
| F | 0.76 | 1.52 | 0.030 | 0.060 | | |
| G | | 0.203 | | 0.008 | | |
| Н | 4.70 | 5.66 | 0.185 | 0.222 | | |

NOTES

- Controlling dimension: millimeters.
 Dimensioning and tolerances per ANSI Y14.5M, 1985.
 Dimensions are exclusive of mold flash and metal burrs.



CUSTOMER NOTE:

DISCLAIMER

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- 2. In Europe, please dispose as per EU Directive 2002/96/EC on Waste Electrical and Electronic Equipment (WEEE).



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